

GTVA220701FA

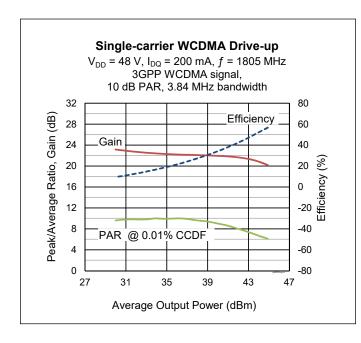
Thermally-Enhanced High Power RF GaN on SiC Amplifier, 70 W, 50 V, 1805 - 2170 MHz

Description

The GTVA220701FA is a 70-watt ($P_{\rm 3dB}$) GaN on SiC HEMT D-mode amplifier for use in multi-standard cellular power amplifier applications. It features input matching, high efficiency, and a thermally-enhanced package with earless flange.



Package Types: H-37265J-2



Features

- GaN on SiC HEMT technology
- Input matched
- Typical CW performance, 1880 MHz, 48 V
 - Output power at P_{3dB} = 45 W
 - Efficiency = 60.7%
 - Gain = 21.6 dB
- Human Body Model, Class 1A (per ANSI/ESDA/ JEDEC JS-001)
- Capable of handling 10:1 VSWR @48 V, 40 W (CW) output power
- RoHS-compliant

RF Characteristics

Single-carrier LTE Specifications (tested in the test fixture)

 V_{DD} = 48 V, I_{DO} = 200 mA, P_{OUT} = 6.3 W avg, f = 2170 MHz, 3GPP signal, 3.84 channel bandwidth, peak/average = 10.6 dB @ 0.01% CCDF

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Gain	G _{ps}	20.75	22	_	dB
Drain Efficiency	$\eta_{\scriptscriptstyle D}$	24.5	27	_	%
Adjacent Channel Power Ratio	ACPR	_	-36.5	-33	dBc
Output PAR at 0.01% probablity on CCDF	OPAR	8.0	8.7	_	dB

All published data at $T_{CASE} = 25^{\circ}C$ unless otherwise indicated ESD: Electrostatic discharge sensitive device—observe handling precautions!





DC Characteristics

Characteristic	Symbol	Min.	Тур.	Max.	Unit	Conditions
Drain-source Breakdown Voltage	V _{BR(DSS)}	150	_	_	V	$V_{GS} = -8 \text{ V}, I_{D} = 7.2 \text{ mA}$
Drain-source Leakage Current	I _{DSS}	_	_	5	mA	$V_{GS} = -8 \text{ V}, V_{DS} = 10 \text{ V}$
Gate Threshold Voltage	V _{GS(th)}	-3.8	-3.0	-2.3	V	$V_{DS} = 10 \text{ V}, I_{D} = 7.2 \text{ mA}$

Recommended Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Drain Operating Voltage	V _{DD}	0	_	50	.,,	
Gate Quiescent Voltage	$V_{GS(Q)}$	_	-2.8	_	V	V _{DS} =48 V, I _D = 0.2 A

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source Voltage	V _{DSS}	125	
Gate-source Voltage	V _{GS}	-10 to +2	V
Operating Voltage	V _{DD}	55	
Gate Current	I _G	7.2	mA
Drain Current	I _D	2.7	Α
Junction Temperature	T _J	225	°C
Storage Temperature Range	T _{STG}	-65 to +150	C

Operation above the maximum values listed here may cause permanent damage. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the component. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For reliable continuous operation, the device should be operated within the operating voltage range (V_{DD}) specified above.

Thermal Characteristics

Characteristics	Symbol	Value	Unit	Conditions
Thermal Resistance	$R_{\theta JC}$	2.36	°C/W	T _{CASE} = 70 °C, 55 W (CW), V _{DD} = 48 V, 2170 MHz

Ordering Information

Type and Version	Order Code	Package Description	Shipping
GTVA220701FA V1 R0	GTVA220701FA-V1-R0	H-37265J-2, earless flange	Tape & Reel, 50 pcs
GTVA220701FA V1 R2	GTVA220701FA-V1-R2	H-37265J-2, earless flange	Tape & Reel, 250 pcs



Typical Performance (data taken in an the production test fixture)

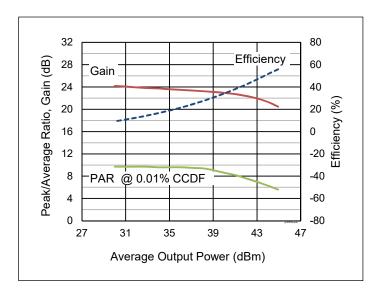


Figure 1. Single-carrier WCDMA Drive-up

 V_{DD} = 48 V, I_{DQ} = 200 mA, f = 1880 MHz 3GPP WCDMA signal, 10 dB PAR, 3.84 MHz bandwidth

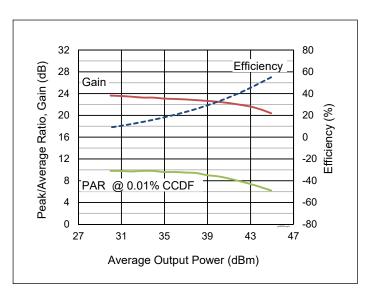


Figure 2. Single-carrier WCDMA Drive-up

 V_{DD} = 48 V, I_{DQ} = 200 mA, f = 2170 MHz 3GPP WCDMA signal, 10 dB PAR, 3.84 MHz bandwidth

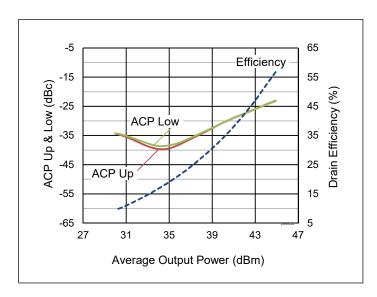


Figure 3. Single-carrier WCDMA Drive-up

 $V_{\rm DD}$ = 48 V, $I_{\rm DQ}$ = 200 mA, f = 1805 MHz, 3GPP WCDMA signal, 10 dB PAR, 3.84 MHz bandwidth

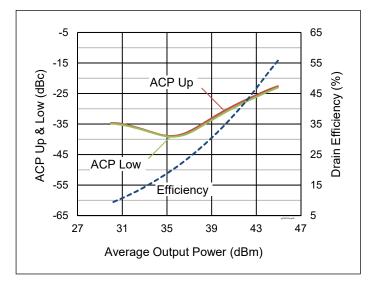


Figure 4. Single-carrier WCDMA Drive-up

 $\begin{array}{c} {\rm V_{DD}=48~V,~I_{DQ}=200~mA,~f=1880~MHz,} \\ {\rm 3GPP~WCDMA~signal,~10~dB~PAR,} \\ {\rm 3.84~MHz~bandwidth} \end{array}$



Typical Performance (cont.)

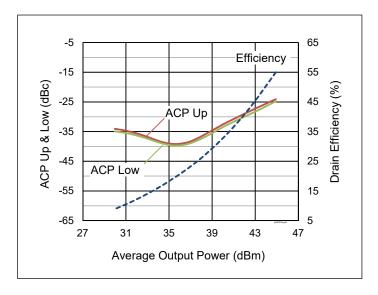


Figure 5. Single-carrier WCDMA Drive-up

 $V_{\rm DD}$ = 48 V, $I_{\rm DQ}$ = 200 mA, f = 2170 MHz, 3GPP WCDMA signal, 10 dB PAR, 3.84 MHz bandwidth

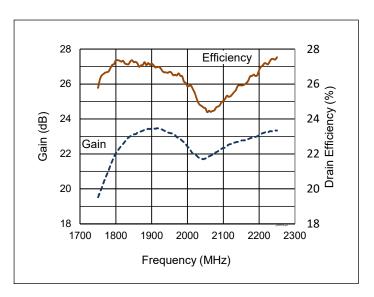


Figure 6. Single-carrier WCDMA Broadband Performance

 V_{DD} = 48 V, I_{DQ} = 200 mA, P_{OUT} = 38.0 dBm, 3GPP WCDMA signal, 10 dB PAR

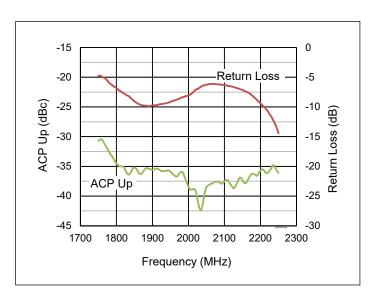


Figure 7. Single-carrier WCDMA Broadband Performance

 $V_{\rm DD}$ = 48 V, $I_{\rm DQ}$ = 200 mA, $P_{\rm OUT}$ = 38.0 dBm, 3GPP WCDMA signal, 10 dB PAR

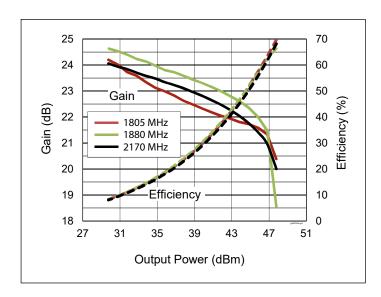


Figure 8. CW Performance

(series show frequency) $V_{DD} = 48 \text{ V}, I_{DQ} = 200 \text{ mA}$



Typical Performance (cont.)

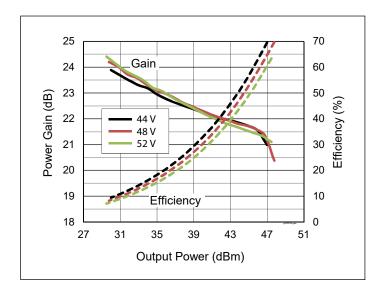


Figure 9. CW Performance at Selected Supply Voltage I_{DQ} = 200 mA, f = 1805 MHz

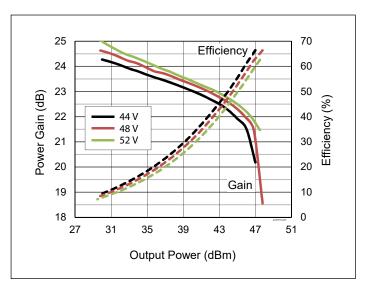


Figure 10. CW Performance at Selected Supply Voltage $I_{DQ} = 200 \text{ mA}, f = 1880 \text{ MHz}$

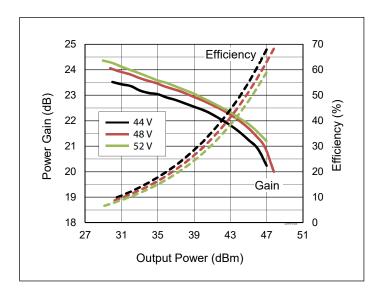


Figure 11. CW Performance at Selected Supply Voltage I_{DQ} = 200 mA, f = 2170 MHz

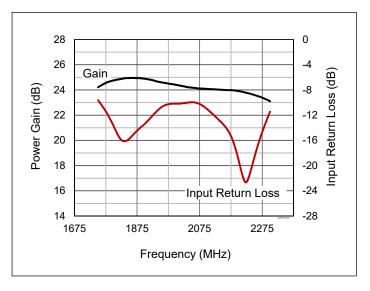
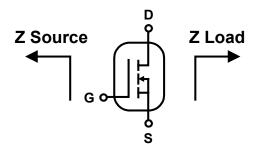


Figure 12. Small Signal CW Gain & Input Return Loss

$$V_{DD}$$
 = 48 V, I_{DQ} = 200 mA



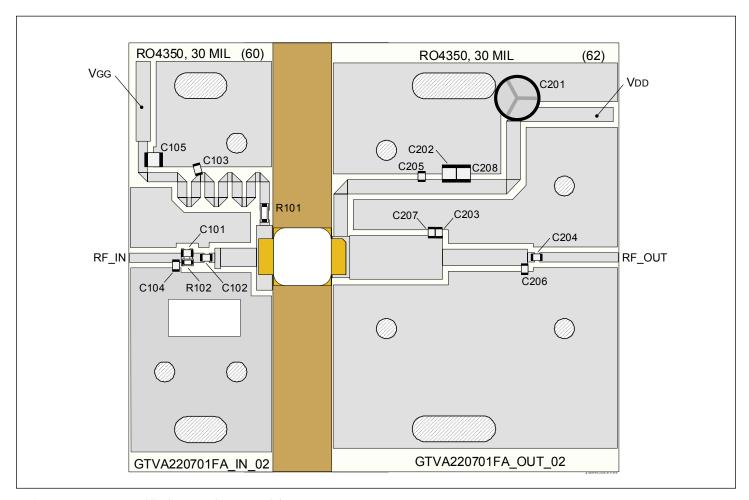
Broadband Circuit Impedance (combined leads)



Freq	Z Sou	ırce Ω	Ω Z Loa	
[MHz]	R	jХ	R	jХ
1805	1.95	-5.67	12.02	5.87
1840	2.01	-6.27	11.94	3.94
1880	2.43	-7.17	11.33	3.15
2100	9.95	-9.38	10.39	0.02
2140	11.40	-8.40	10.31	-0.75
2170	11.61	-9.07	10.50	-2.23

Evaluation Board, 1805 MHz to 2170 MHz

Evaluation Board Part Number	LTN/GTVA220701FA-V1
PCB Information	Rogers 4350, 0.762 mm [.030"] thick, 2 oz. copper, ε _r = 3.66



Reference circuit assembly diagram (not to scale)



Components Information

Component	Description	Manufacturer	P/N
Input			
C101	Capacitor, 2.4 pF	ATC	ATC600F2R4JT250XT
C102, C103	Capacitor, 20 pF	ATC	ATC600F200JT250XT
C104	Capacitor, 1 pF	ATC	ATC600F1R0JT250XT
C105	Capacitor, 10 μF	Taiyo Yuden	UMK325C7106MM-T
R101	Resistor, 10 ohms	Panasonic Electronic Components	ERJ-8GEYJ100V
R102	Resistor, 330 ohms	Panasonic Electronic Components	ERJ-3GEYJ331V
Output			
C201	Capacitor, 47 μF	Cornell Dubilier Electronics (CDE)	SEK470M100ST
C202, C208	Capacitor, 10 μF	Taiyo Yuden	UMK325C7106MM-T
C203	Capacitor, 1 pF	ATC	ATC600F1R0JT250XT
C204, C205	Capacitor, 20 pF	ATC	ATC600F200JT250XT
C206	Capacitor, 0.7 pF	ATC	ATC600F0R7JT250XT
C207	Capacitor, 0.3 pF	ATC	ATC600F0R3JT250XT

Bias Sequencing

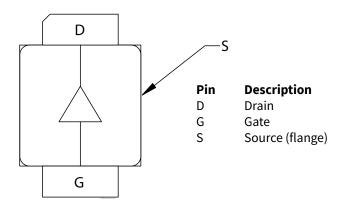
Bias On

- 1. Ensure RF is turned off
- 2. Apply pinch-off voltage of -5 V to the gate
- 3. Apply nominal drain voltage
- 4. Bias gate to desired quiescent drain current
- 5. Apply RF

Bias Off

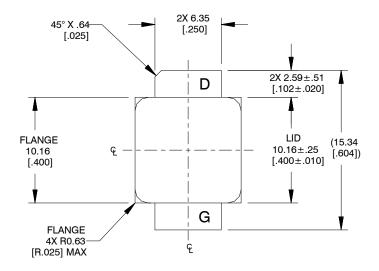
- 1. Turn RF off
- 2. Apply pinch-off voltage to the gate
- 3. Turn-off drain voltage
- 4. Turn-off gate voltage

Pinout Diagram (top view)





Package Outline Specifications - Package H-37265J-2



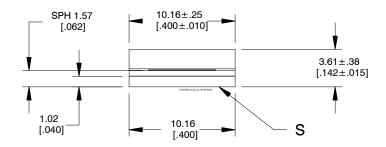


Diagram Notes—unless otherwise specified:

- 1. Interpret dimensions and tolerances per ASME Y14.5M-1994.
- 2. Primary dimensions are mm. Alternate dimensions are inches.
- 3. All tolerances ± 0.127 [.005] unless specified otherwise.
- 4. Pins: D drain; G gate; S source.
- 5. Lead thickness: 0.10 + 0.051/-0.025 mm [.004 +0.002/-0.001 inch].
- 6. Gold plating thickness: 1.14 ± 0.38 micron [45 ± 15 microinch].



Notes & Disclaimer

MACOM Technology Solutions Inc. ("MACOM"). All rights reserved.

These materials are provided in connection with MACOM's products as a service to its customers and may be used for informational purposes only. Except as provided in its Terms and Conditions of Sale or any separate agreement, MACOM assumes no liability or responsibility whatsoever, including for (i) errors or omissions in these materials; (ii) failure to update these materials; or (iii) conflicts or incompatibilities arising from future changes to specifications and product descriptions, which MACOM may make at any time, without notice. These materials grant no license, express or implied, to any intellectual property rights.

THESE MATERIALS ARE PROVIDED "AS IS" WITH NO WARRANTY OR LIABILITY, EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF MACOM PRODUCTS INCLUDING FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, INFRINGEMENT OF INTELLECTUAL PROPERTY RIGHT, ACCURACY OR COMPLETENESS, OR SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES WHICH MAY RESULT FROM USE OF THESE MATERIALS.

MACOM products are not intended for use in medical, lifesaving or life sustaining applications. MACOM customers using or selling MACOM products for use in such applications do so at their own risk and agree to fully indemnify MACOM for any damages resulting from such improper use or sale.